

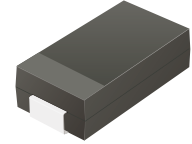
ES1A-HF Thru. ES1J-HF

Reverse Voltage: 50 to 600 Volts

Forward Current: 1 Amp

RoHS Device

Halogen Free



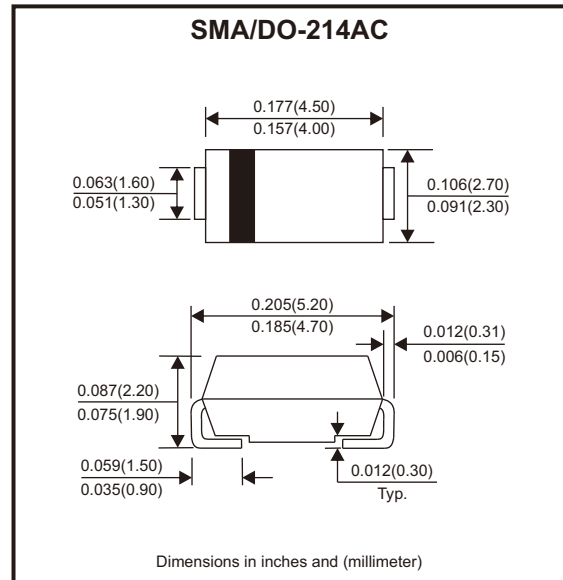
Features

- For surface mounted applications.
- Low profile package.
- Glass passivated chip junction.
- Super fast reverse recovery time.

Mechanical data

- Case: SMA
- Terminals: Solderable per MIL-STD-750, method 2026.

Circuit Diagram



Maximum Ratings and Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.
Single phase, half wave, 60Hz resistive or inductive load, for capacitive load, derate by 20%

Parameter	Symbols	ES1A -HF	ES1B -HF	ES1C -HF	ES1D -HF	ES1E -HF	ES1G -HF	ES1J -HF	Units
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	150	200	300	400	600	V
Maximum RMS voltage	V_{RMS}	35	70	105	140	210	280	420	V
Maximum DC blocking voltage	V_{DC}	50	100	150	200	300	400	600	V
Maximum average forward rectified current	$I_{F(AV)}$	1							A
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	30							A
Max. forward voltage at 1A	V_F	1.0				1.25		1.70	V
Maximum DC reverse current at rated DC blocking voltage $T_a = 25^\circ\text{C}$ $T_a = 125^\circ\text{C}$	I_R	5 100							μA
Typical junction capacitance at $V_R = 4\text{V}$, $f = 1\text{MHz}$	C_j	15							pF
Maximum reverse recovery time (Note 1)	t_{rr}	35							ns
Typical thermal resistance (Note 2)	$R_{\theta JA}$	75							$^\circ\text{C/W}$
Operating and storage temperature range	T_j, T_{stg}	-55 ~ +150							$^\circ\text{C}$

Notes: 1. Measured with $I_F = 0.5\text{A}$, $I_R = 1\text{A}$, $I_{rr} = 0.25\text{A}$.
2. P.C.B. mounted with 1.0 x 1.0" (2.54 x 2.54 cm) copper pad areas.

Company reserves the right to improve product design, functions and reliability without notice.

REV:A

Rating and Characteristic Curves (ES1A-HF Thru. ES1J-HF)

Fig.1 - Max. Average Forward Current Rating

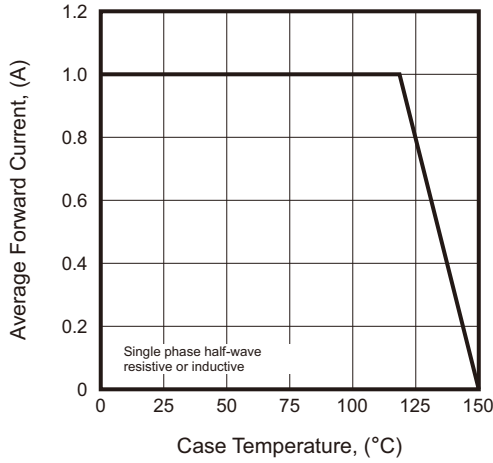


Fig.2 - Typical Reverse Characteristics

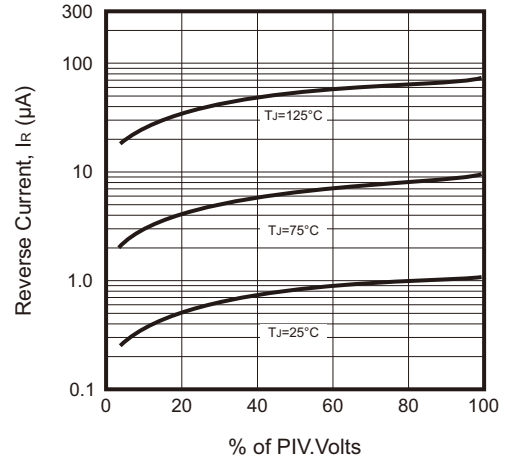


Fig.3 - Typical Forward Characteristic

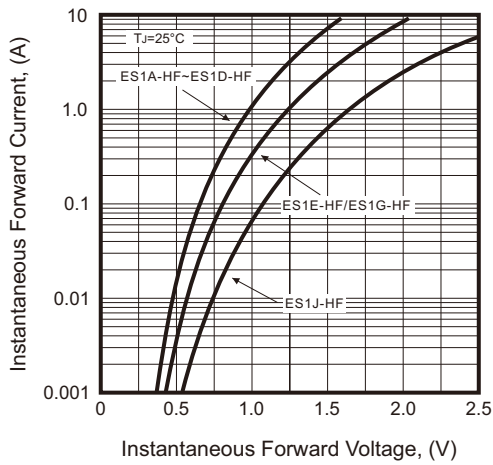


Fig.4 - Typical Junction Capacitance

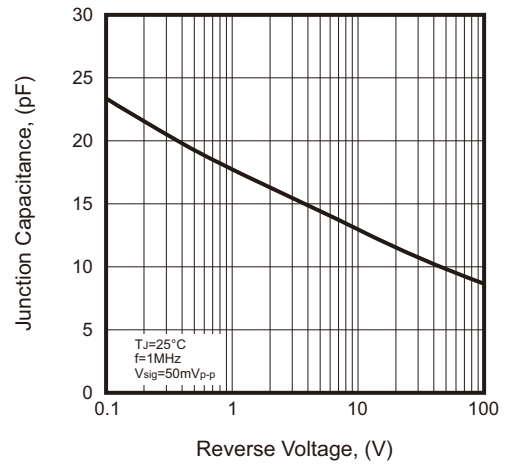
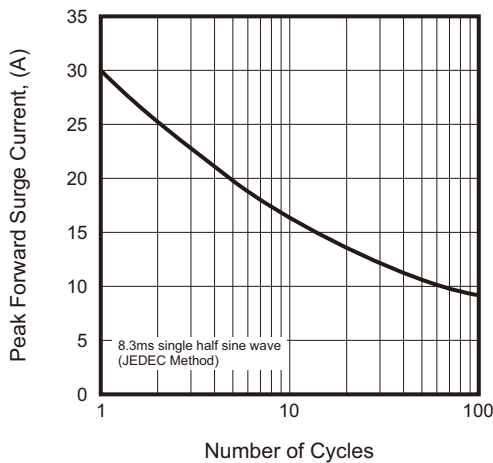
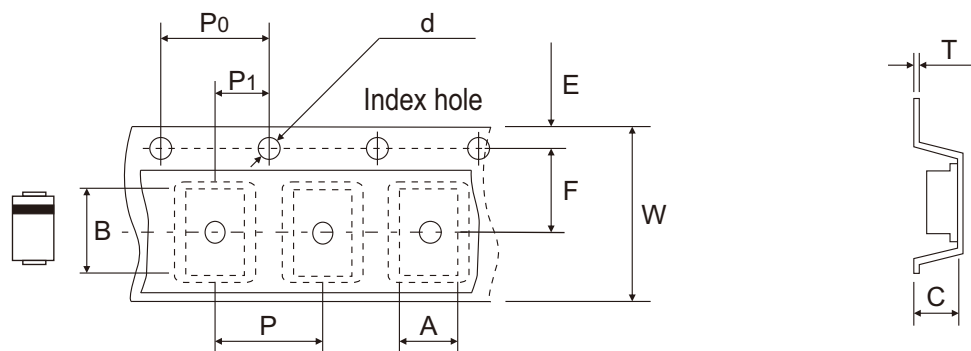


Fig.5 - Maximum Non-Repetitive Peak Forward Surge Current



Reel Taping Specification



DO-214AC (SMA)	SYMBOL	A	B	C	d	D	D1	D2
	(mm)	2.70 ± 0.10	5.33 ± 0.10	2.35 ± 0.10	1.55 ± 0.05	330 ± 2.00	75.00 ± 1.00	13.00 ± 0.20
	(inch)	0.106 ± 0.004	0.210 ± 0.004	0.093 ± 0.004	0.061 ± 0.002	12.992 ± 0.079	2.953 ± 0.039	0.512 ± 0.008

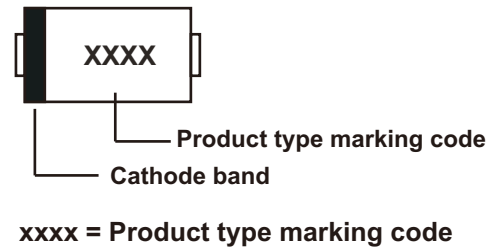
DO-214AC (SMA)	SYMBOL	E	F	P	P0	P1	T	W	W1
	(mm)	1.75 ± 0.10	5.50 ± 0.05	4.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.10	0.20 ± 0.03	12.00 ± 0.30	14.70 + 2.00 - 1.00
	(inch)	0.069 ± 0.004	0.217 ± 0.002	0.157 ± 0.004	0.157 ± 0.004	0.079 ± 0.004	0.008 ± 0.001	0.472 ± 0.012	0.579 + 0.079 - 0.039

Company reserves the right to improve product design, functions and reliability without notice.

REV:A

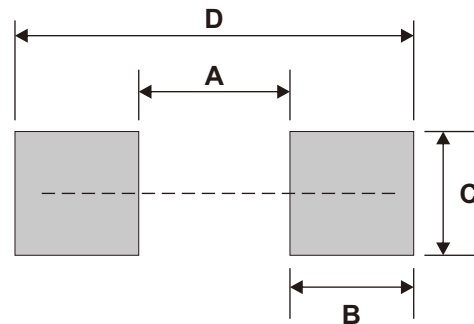
Marking Code

Part Number	Marking Code
ES1A-HF	ES1A
ES1B-HF	ES1B
ES1C-HF	ES1C
ES1D-HF	ES1D
ES1E-HF	ES1E
ES1G-HF	ES1G
ES1J-HF	ES1J



Suggested PAD Layout

SIZE	DO-214AC (SMA)	
	(mm)	(inch)
A	2.40	0.094
B	1.80	0.071
C	1.80	0.071
D	6.00	0.236



Note: 1. The pad layout is for reference purpose only.

Standard Packaging

Case Type	REEL PACK	
	REEL (pcs)	Reel Size (inch)
DO-214AC (SMA)	5,000	13